

### ZHCS756

#### SURFACE MOUNT SCHOTTKY BARRIER DIODE

### **Product Summary**

- V<sub>R</sub> = 60V
- I<sub>F</sub> = 750mA
- I<sub>R</sub> = 50μA

### **Description and Applications**

- DC DC Converters
- Mobile Telecomms
- PCMIA

#### **Features and Benefits**

- High current capability (I<sub>F</sub> = 750mA)
- Low V<sub>F</sub>
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.0089 grams (approximate)

SOT23

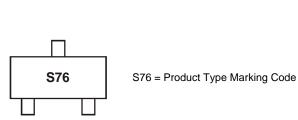
#### Top View

# Ordering Information (Note 1)

Device		Packaging	Shipping
ZHCS756TA		SOT23	3000/Tape & Reel
	000000		

Notes: 1. For Packaging Details, go to our website at http://www.diodes.com.

## **Marking Information**





## **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Characte	Symbol	Value	Units	
Continuous Reverse Voltage	V <sub>R</sub>	60	V	
Continuous Forward Current	lF	750	mA	
Forward Voltage @ I <sub>F</sub> = 750mA	VF	610	mV	
Average Peak Forward Current; D.C. = 50%		I <sub>FAV</sub>	1500	mA
Non Repetitive Forward Current	t ≤ 100μs		12	А
	t ≤ 10ms	IFSM	5	A

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation, $T_A = 25^{\circ}C$	PD	500	mW
Junction Temperature	TJ	125	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

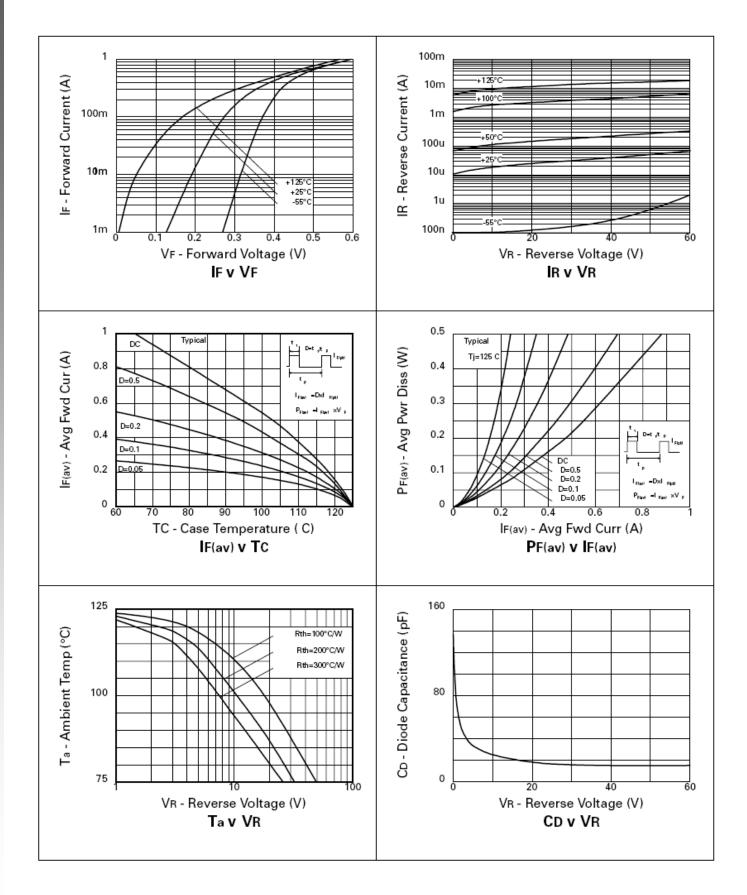
## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V <sub>(BR)R</sub>	60	80	-	V	I <sub>R</sub> = 300μA
	VF	-	250	290	mV	I <sub>F</sub> = 50mA
		-	285	330		I <sub>F</sub> = 100mA
		-	350	410		I <sub>F</sub> = 250mA
Forward Voltage (Note 2)		-	440	500		I <sub>F</sub> = 500mA
		-	520	610		I <sub>F</sub> = 750mA
		-	600	700		$I_F = 1A$
		-	760	900		I <sub>F</sub> = 1.5A
Reverse Current	I <sub>R</sub>	-	50	100	μA	V <sub>R</sub> = 45V
Diode Capacitance	CD	-	17	-	pF	f = 1MHz, V <sub>R</sub> = 25V
Reverse Recovery Time	trr	-	12	-	ns	Switched from $I_F = 500$ mA to $I_R = 500$ mA Measured @ $I_R = 50$ mA

Notes: 2. Measured under pulsed conditions. Pulse width =  $300\mu$ S. Duty cycle  $\leq 2\%$ .



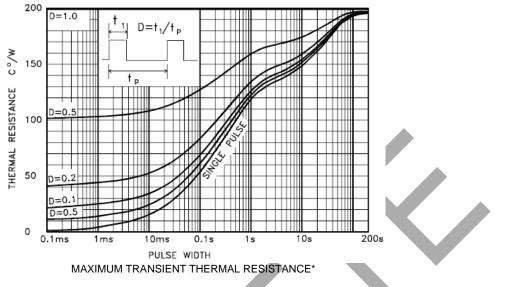
**ZHCS756** 





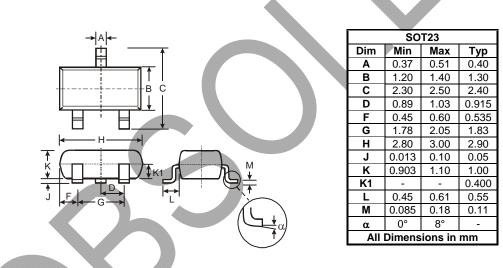
PART OBSOLETE - USE SBR160S23

#### **ZHCS756**

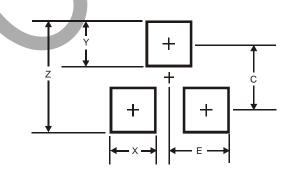


\* Reference above figure, devices were mounted on a 15mmx15mm ceramic substrate.

# **Package Outline Dimensions**



# Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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